

#### Features

- 1808 0.55mm SMD LED
- High Brightness
- InGaN Technology
- Small package
- High reliability

#### **Applications**

- Consumer Electronics
- Wearable
- Automobile After Market
- Industrial Equipment

### Description

The IN-P18ATG is a popular low profile 1808 package with versatile design capabilities. It is a PLCC type silicone style LED which can be used in various applications.

# **Recommended Solder Pattern**

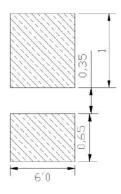
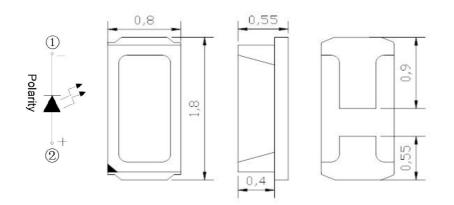


Figure 1. IN-P18ATG Solder Pattern



#### Package Dimensions in mm

#### Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is  $\pm$  0.10 mm unless otherwise noted





## Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>st</sub> (°C)
IN-P18ATG	Green	90	25	100	5	-30°C~+85°C	-40°C~+90°C

#### **Notes**

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### **ESD** Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



## **Electrical Characteristics** $T_A = 25$ °C (Note 1)

	Emission		V <sub>F</sub> (	(V)		λ(nm)		Viewing Angle	l <sup>*</sup> √(mcd)
Product	luct Emission Color		min	max	$\lambda_{D}$	$\lambda_{P}$	Δλ	201/2	typ.
IN-P18AT	G Green	20	2.8	3.6	521	515	25	120	1000

#### Notes

1. Performance guaranteed only under conditions listed in above tables.

#### Luminous Intensity (mcd) Bin:

Bin	Luminous Intensity (mcd)					
	Minimum	Maximum				
Q1	720	900				
Q2	900	1150				
R1	1150	1400				
R2	1400	1800				
S1	1800	2300				

@20mA / Ta=25<sup>o</sup> C, Tolerance: ±15%

### Wavelength (nm) Bin:

Color	Bin Code	Spec. Range
	В	515-518 nm
Green	С	518-521 nm
Green	E	521-524 nm
	F	524-527 nm

@20mA / Ta=25 $^{\circ}$ C , Tolerance: ±1.0nm

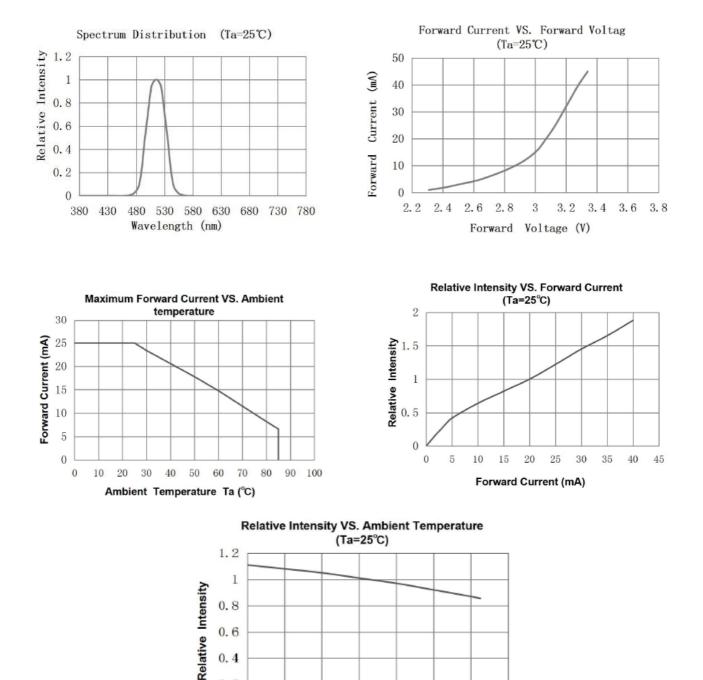
### Forward Voltage (VF) Bin:

Color	Bin Code	Spec. Range
	6	2.8-3.0 nm
Green	2	3.0-3.2 nm
Green	3	3.2-3.4 nm
	4	3.4-3.6 nm

@20mA / Ta=25 $^\circ\!\mathrm{C}$  , Tolerance: ±0.1 V



#### **Typical Characteristic Curves**



0.4

-20

0

20

Ambient Temperature Ta (°C)

40

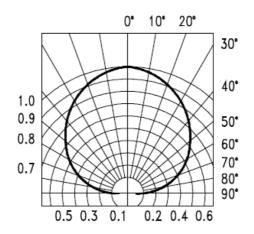
60

80

100



### **Typical Characteristic Curves – Radiation Pattern**

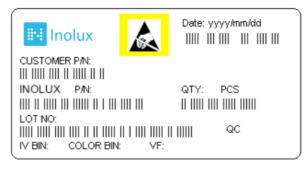


# **Ordering Information**

Product	Emission Color	Technology		Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-P18ATG	Green	InGaN	20	1000	3.2	IN-P18ATG



### **Label Specifications**



# Inolux P/N:

I	Ν	-	Р	1	8	А	Т			G	-	-	-	-	-
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color			istorr tamp		
Inc	blux		P = PLCC Type	18A =	: 1.8 x 0	9.8 x 0.55mm	T = Top Mount	(Blank) = 20mA	(Blank) = Clear U = Diffused	G=525nm			-		

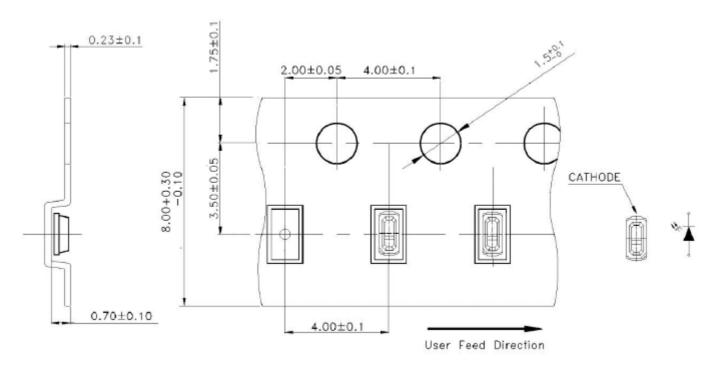
#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017)	2018 \	Month	Date	Serial	
Tracker		Tear (2017)	, 2018,)		Month	Date	Senai

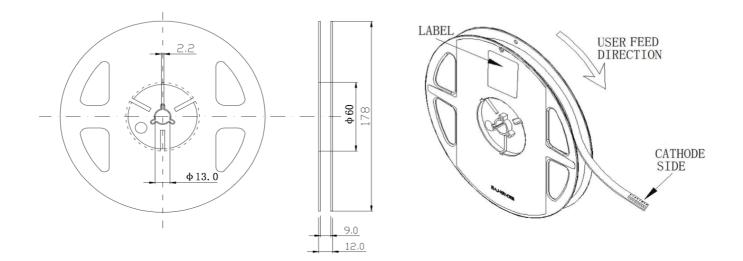


## Packaging Information: 4000pcs Per Reel

# Tape Dimension

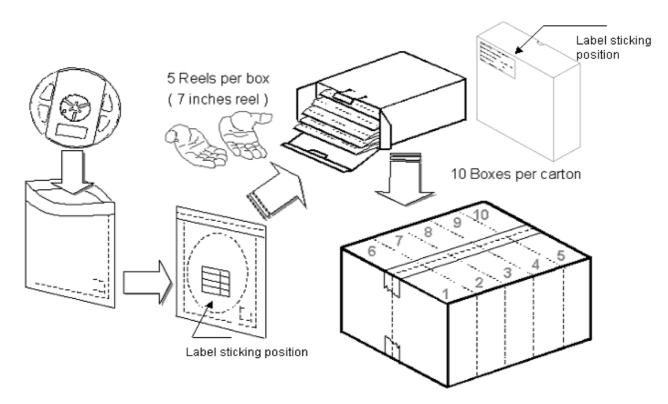


# **Reel Dimension**





### Packing Dimension



5 boxes per carton are available depending on shipment quantity.

Specification	Material	Quantity
Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Per EIA 481-1A specs	Conductive black	
IN standard	Paper	
220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
IN standard	Paper	Non-specified
	Per EIA 481-1A specs Per EIA 481-1A specs IN standard 220x240mm	Per EIA 481-1A specs       Conductive black tape         Per EIA 481-1A specs       Conductive black         IN standard       Paper         220x240mm       Aluminum laminated bag/ no-zipper

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

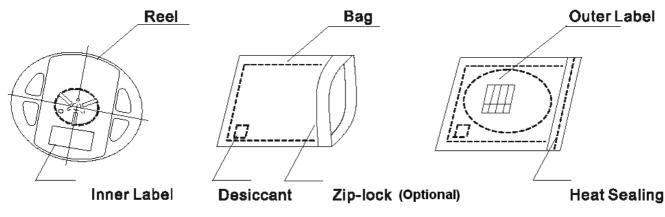


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

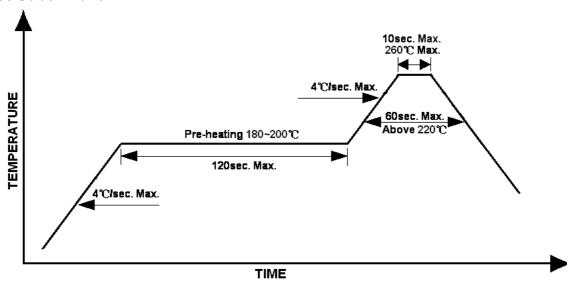
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



#### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



#### Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

#### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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# **Reliability**

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	<ol> <li>Precondition: 85°C baking for 24hrs</li> <li>85°C/ 60%R.H. for 168hrs</li> <li>Tamb25°C; IF=20mA; duration 1000hrs</li> </ol>
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 $\mu$ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs



#### **Revision History**

Changes since last revision	Page	Version No.	<b>Revision Date</b>
Initial Release		1.0	05-12-2021

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